

General Description

The SJJ68N030 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 10V. This device is suitable for use as a wide variety of applications.

Features

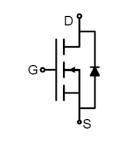
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handing capability
- Lead free product is acquired

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

Key Performance Parametes

Parameter	Value	Unit
V _{DS}	68	V
R _{DS(ON)_TYP}	2.9	mΩ
ID	165	А
Q _G	152	nC







Schematic Diagram

TO-263 top view

Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJJ68N030	SJJ68N030	TO-263	Таре	/	\	1000 Pcs

Table 1. Absolute Maximum Ratings ($T_c=25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Limit	Unit
V _{DS}	Drain-Source Voltage (V _{GS} =0V)	68	V
V _{GS}	Gate-Source Voltage (V _{DS} =0V)	±20	V
1-	Drain Current-Continuous(Tc=25°C)	165	А
١D	Drain Current-Continuous($T_C=100^{\circ}C$)	105	А
IDM (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	660	А
P	Maximum Power Dissipation(T_c=25 $^\circ\!\mathrm{C}$)	208	W
PD	Maximum Power Dissipation(Tc=100 $^{\circ}$ C)	83	W
E _{AS}	Avalanche energy (Note 2)	400	mJ
TJ, TSTG	Operating Junction and Storage Temperature Range	-55 To 150	Ĉ

Table 2. Thermal Characteristic

Sy	mbol	Parameter	Тур	Max	Unit
F	S ejc	Thermal Resistance, Junction-to-Case		0.6	°C/W

Table 3. Electrical Characteristics (TJ=25℃ unless otherwise noted)

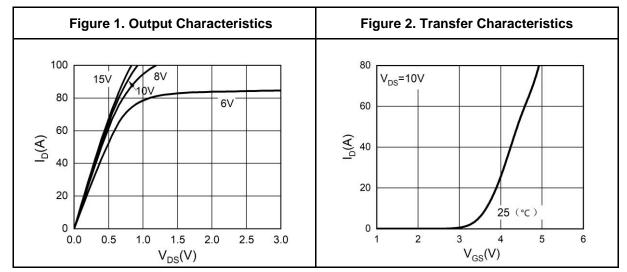
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
On/Off States						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V I _D =250µA	68			V
1	Zara Cata Valtara Drain Ourrant	V _{DS} =68V, V _{GS} =0V TJ=25℃			1	μA
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =68V, V _{GS} =0V T _J =125℃			100	μA
lgss	Gate-Body Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$			±100	nA
$V_{GS(th)}$	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250µA	2		4	V
g fs	Forward Transconductance	V _{DS} =10V, I _D =20A		39		S
RDS(ON)	Drain-Source On-State Resistance	V _{GS} =10V, I _D =20A T _J =25℃		2.9	3.8	mΩ
Dynamic Chara	cteristics	•			-	•
Ciss	Input Capacitance			9270		pF
Coss	Output Capacitance	V _{DS} =34V,V _{GS} =0V, f=1.0MHz		484		pF
Crss	Reverse Transfer Capacitance			443		pF
Rg	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1.0MHz		0.44		Ω
Switching Para	meters					
t _{d(on)}	Turn-on Delay Time			29.6		nS
tr	Turn-on Rise Time	V _{GS} =10V, V _{DS} =34V, R _L =1.7Ω, R _{GEN} =3Ω		66.4		nS
t _{d(off)}	Turn-Off Delay Time			118		nS
t _f	Turn-Off Fall Time			24		nS
Qg	Total Gate Charge			152		nC
Qgs	Gate-Source Charge	V _{GS} =10V, V _{DS} =34V, I _D =20A		32		nC
Q_gd	Gate-Drain Charge			40		nC
Source-Drain D	iode Characteristics					
Isd	Source-Drain Current (Body Diode)				165	А
Vsd	Forward on Voltage (Note 3)	V _{GS} =0V, I _S =20A			1.2	V
trr	Reverse Recovery Time	I⊧=20A, dl/dt=100A/μs		58		ns
Qrr	Reverse Recovery Charge	l⊧=20A, dl/dt=100A/μs		70		nC
	1					•

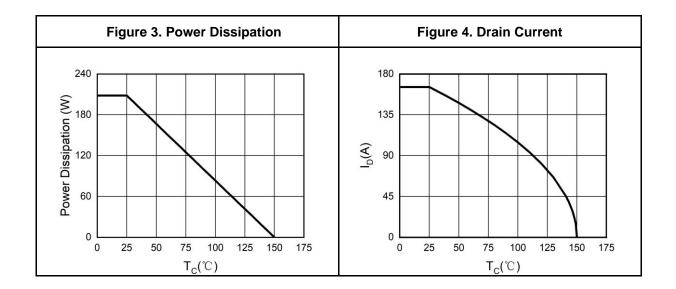
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature. Notes 2.E_{AS} condition: T_J =25°C, V_{DD} =40V, V_G =10V, Rg=25 Ω , L=0.5mH.

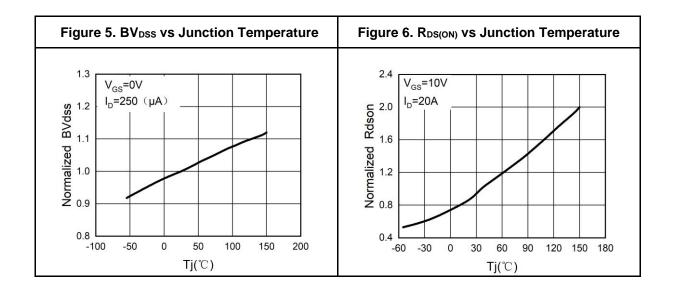
Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.

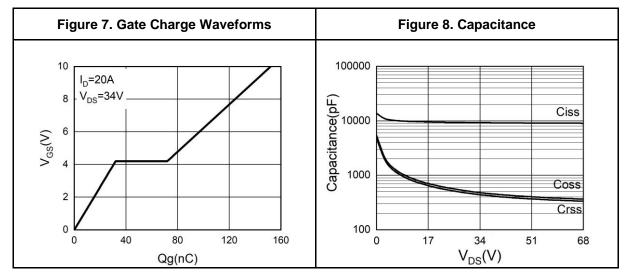


Typical Electrical And Thermal Characteristics (Curves)

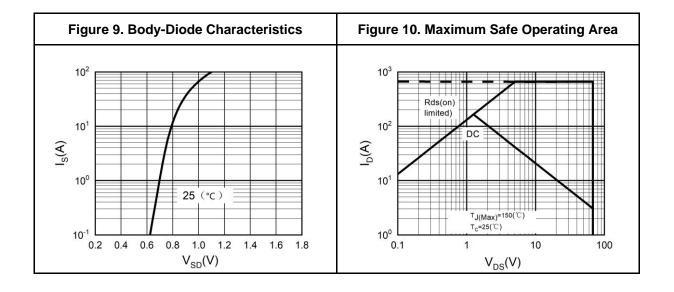






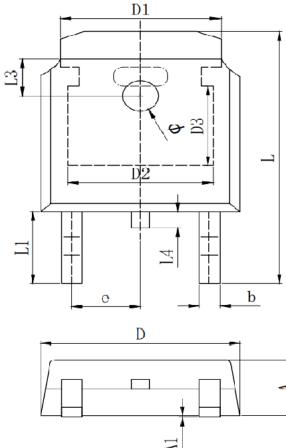


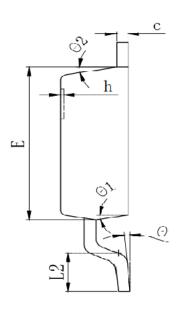
Typical Electrical And Thermal Characteristics (Curves)





TO-263 Package Information





Symbol	Dimensions In Millimeters				
	Min.	Тур.	Max.		
А	2.200	2.300	2.400		
A1	0.000		0.127		
b	0.640	0.690	0.740		
c(电镀后)	0.460	0.520	0.580		
D	6.500	6.600	6.700		
D1	5.334 REF				
D2	4.826 REF				
D3	3.166 REF				
E	6.000	6.100	6.200		
е		2.286 TYP			
h	0.000	0.100	0.200		
L	9.900	10.100	10.300		
L1		2.888 REF			
L2	1.400	1.550	1.700		
L3		1.600 REF			
L4	0.600	0.800	1.000		
Φ	1.100	1.200	1.300		
θ	0°		8°		
θ1	9° TYP				
θ2		9° TYP			

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